#### Особенности:

- 1310нм DFB лазер для SFP-MR.WDM3.40
- 1550нм DFB лазер для SFP-MR.WDM5.40
- 40км бюджет на SMF
- возможность горячей замены
- SC разъем
- встроенная функция диагностики (DDMI) в соответствии с SFF-8472
- 2.67Gbps Data rate

#### Области применения:

- 1Fiber Channel, Gigabit Ethernet
- OC-48 / STM-16

#### Absolute Maximum Ratings

Parameter		Symbol	Min.	Typical	Max.	Unit
Operating Case Temperature		T <sub>A</sub>	0		+70	°C
Power Supply Voltage		V <sub>cc</sub>	3.15	3.3	3.45	V
Power Supply Current		I <sub>cc</sub>			300	mA
Date Rate	FC			1.063		Gbps
	2xFC			2.125		Gbps
	OC-48/STM-16			2.5		Gbps

### **Performance Specifications - Electrical**

Parameter		Symbol	Min.	Тур.	Мах	Unit	Notes	
	Transmitter							
LVPECL Compatible Inputs(Differential)		Vin	400		2000	mVpp	AC coupled inputs*(note5)	
Input Impedance (Differential)		Zin	85	100	115	ohms	Rin > 100 kohms @ DC	
Tx_Dis	Disable		2		Vcc	V		
	Enable		0		0.8			
Tx_FAUL	Fault		2		Vcc+0.3	V		
Т	Normal		0		0.5			
			R	eceive	r			
CML Outputs (Differential)		Vout	370		1200	mVpp	AC coupled outputs*(note5)	
Output Impedance (Differential)		Zout	85	100	115	ohms		
Rx_LOS	LÓS		2		Vcc+0.3	V		
	Normal		0		0.8	V		





MOD_DEF ( 0:2 )	VoH	2.5		V	With Serial ID
	VoL	0	0.5	V	

### **Optical and Electrical Characteristics**

#### (SFP-MR.WDM3.40, 1310nm DFB and PIN, 40km)

Parameter	Symbol	Min.	Typical	Max.	Unit	
9µm Core Diameter SMF	L		40		km	
Data Rate		1.063		2.67	Gbps	
	Transmitte	er				
Centre Wavelength	λ <sub>c</sub>	1260	1310	1360	nm	
Spectral Width (-20dB)	Δλ			1	nm	
Side Mode Suppression Ratio	SMSR	30			dB	
Average Output Power*(note3)	Pout	0		5	dBm	
Extinction Ratio*(note4)	ER	8.2			dB	
Rise/Fall Time(20% ~ 80%)	tr/tf			150	ps	
Output Optical Eye*(note4)	(	Compatible	with ITU-T G	5.957*(note7)		
TX_Disable Assert Time	t_off			10	Eus	
Pout@TX Disable Asserted	Pout			-45	dBm	
	Receive	r		11		
Centre Wavelength	λ <sub>c</sub>	1500	1550	1580	nm	
Receiver Sensitivity*(note6)	Pmin			-20	dBm	
Receiver Overload	Pmax	0			dBm	
Reflection				-27	dB	
LOS De-Assert	LOSD			-19	dBm	
LOS Assert	LOSA	-45			dBm	
LOS Hysteresis*(note8)		0.5			dB	
SFP-MR.WDM5.40, 1550nm DFB	and PIN, 40k	m)				
Parameter	Symbol	Min.	Typical	Max.	Unit	
9µm Core Diameter SMF	L		40		km	
Data Rate		1.063		2.67	Gbps	
	Transmitte	er	ļ	ļļ		
Centre Wavelength	λ <sub>c</sub>	1530	1550	1570	nm	
Spectral Width (-20dB)	Δλ			1	nm	
Average Output Power*(note3)	Pout	0		5	dBm	
Extinction Ratio*(note4)	ER	8.2			dB	
Side Mode Suppression Ratio	SMSR	30			dB	
Rise/Fall Time(20% ~ 80%)	tr/tf			150	ps	
Output Optical Eye*(note4)	Compatible with ITU-T G.957*(note7)					
TX_Disable Assert Time	t_off			10	Eus	
	_	-	I	1		
	Receiver					
Centre Wavelength	Receiver   λ <sub>c</sub>	1260		1360	nm	
Centre Wavelength Receiver Sensitivity <sup>*(note6)</sup>				1360 -20	nm dBm	
U	λ <sub>c</sub>					
Receiver Sensitivity*(note6)	λ <sub>c</sub> Pmin	1260			dBm	

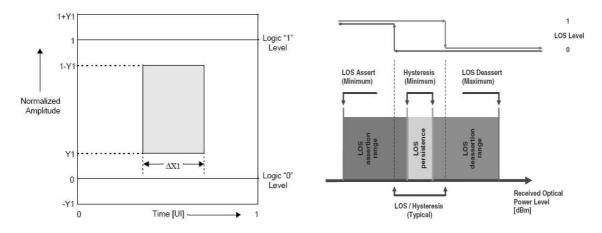
LOS De-Assert	LOSD		-19	dBm
LOS Assert	LOSA	-45		dBm
LOS Hysteresis*(note8)		0.5		dB

Note3: Output is coupled into a 9/125µm single-mode fiber.

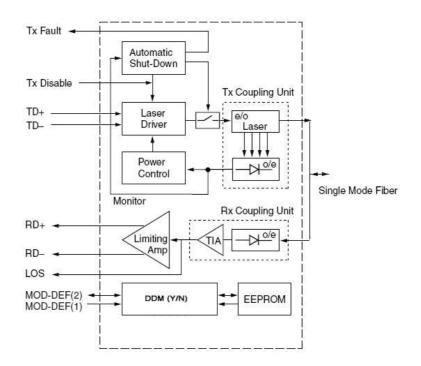
Note4: Filtered, measured with a PRBS 223-1 test pattern @2500Mbps

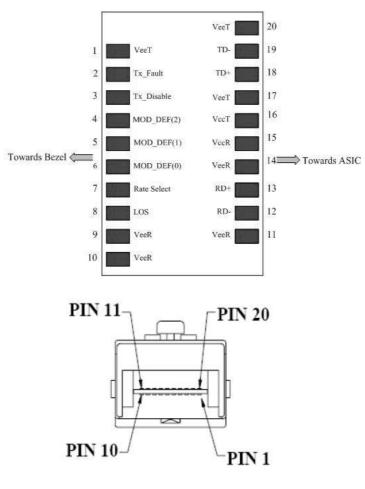
Note5: LVPECL/CML logic, internally AC coupled.

Note6: Measured at all data rates specified in Data Rate table with ER=9 dB, 2<sup>23</sup>-1 PRBS data pattern, BER <1E-10. Note7: Eye pattern mask Note8: LOS Hysteresis



#### **Functional Description of Transceiver**





## SFP Transceiver Electrical Pad Layout

### **Pin Function Definitions**

Pin Num.	Name	FUNCTION	Plug	Notes
1	VeeT	Transmitter Ground	1	5)
2	TX Fault	Transmitter Fault Indication	3	1)
3	TX Disable	Transmitter Disable	3	2), Module disables on high or open
4	MOD- DEF2	Module Definition 2	3	3), Data line for Serial ID.
5	MOD- DEF1	Module Definition 1	3	3), Clock line for Serial ID.
6	MOD- DEF0	Module Definition 0	3	3), Grounded within the module.
7	Rate Select	Not Connect	3	Function not available
8	LOS	Loss of Signal	3	4)
9	VeeR	Receiver Ground	1	5)
10	VeeR	Receiver Ground	1	5)

11	VeeR	Receiver Ground	1	5)
12	RD-	Inv. Received Data Out	3	6)
13	RD+	Received Data Out	3	7)
14	VeeR	Receiver Ground	1	5)
15	VccR	Receiver Power	2	3.3 ± 5%, 7)
16	VccT	Transmitter Power	2	3.3 ± 5%, 7)
17	VeeT	Transmitter Ground	1	5)
18	TD+	Transmit Data In	3	8)
19	TD-	Inv. Transmit Data In	3	8)
20	VeeT	Transmitter Ground	1	5)

Notes:

1) TX Fault is an open collector/drain output, which should be pulled up with a  $4.7K - 10K\Omega$  resistor on the host board. Pull up voltage between 2.0V and VccT, R+0.3V. When high, output indicates a laser fault of some kind. Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.

2) TX disable is an input that is used to shut down the transmitter optical output. It is pulled up within the module with a  $4.7 - 10 \text{ K} \Omega$  resistor. Its states are:

Low (0 – 0.8V): Transmitter on (>0.8, < 2.0V): Undefined High (2.0 – 3.465V): Transmitter Disabled Open: Transmitter Disabled

3) Mod-Def 0,1,2. These are the module definition pins. They should be pulled up with a  $4.7K - 10K\Omega$  resistor on the host board. The pull-up voltage shall be VccT or VccR (see Section IV for further details). Mod-Def 0 is grounded by the module to indicate that the module is present Mod-Def 1 is the clock line of two wire serial interface for serial ID Mod-Def 2 is the data line of two wire serial interface for serial ID

4) LOS (Loss of Signal) is an open collector/drain output, which should be pulled up with a  $4.7K - 10K\Omega$  resistor. Pull up voltage between 2.0V and VccT, R+0.3V. When high, this output indicates the received optical power is below the worst-case receiver sensitivity (as defined by the standard in use). Low indicates normal operation. In the low state, the output will be pulled to < 0.8V.

5) VeeR and VeeT may be internally connected within the SFP module.

6) RD-/+: These are the differential receiver outputs. They are AC coupled  $100\Omega$  differential lines which should be terminated with  $100\Omega$  (differential) at the user SERDES. The AC coupling is done inside the module and is thus not required on the host board. The voltage swing on these lines will be between 370 and 2000 mV differential (185 –1000 mV single ended) when properly terminated.

7) VccR and VccT are the receiver and transmitter power supplies. They are defined as  $3.3V \pm 5\%$  at the SFP connector pin. Maximum supply current is 300mA. Recommended host board power supply filtering is shown below. Inductors with DC resistance of less than 1 ohm should be used in order to maintain the required voltage at the SFP input pin with 3.3V supply voltage. When the recommended supply-filtering network is used, hot plugging of the SFP transceiver module will result in an inrush

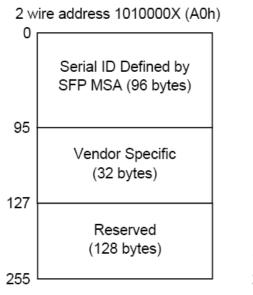
current of no more than 30mA greater than the steady state value. VccR and VccT may be internally connected within the SFP transceiver module.

8) TD-/+: These are the differential transmitter inputs. They are AC-coupled, differential lines with  $100\Omega$  differential termination inside the module. The AC coupling is done inside the module and is thus not required on the host board. The inputs will accept differential swings of 500 - 2400 mV (250 - 1200 mV single-ended), though it is recommended that values between 500 and 1200 mV differential (250 - 600 mV single-ended) be used for best EMI performance.

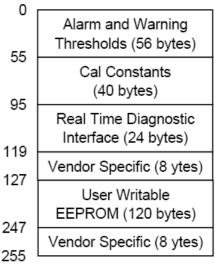
#### EEPROM

The serial interface uses the 2-wire serial CMOS EEPROM protocol defined for the ATMEL AT24C02/04 family of components. When the serial protocol is activated, the host generates the serial clock signal (SCL). The positive edge clocks data into those segments of the EEPROM that are not writing protected within the SFP transceiver. The negative edge clocks data from the SFP transceiver. The serial data signal (SDA) is bi-directional for serial data transfer. The host uses SDA in conjunction with SCL to mark the start and end of serial protocol activation. The memories are organized as a series of 8-bit data words that can be addressed individually or sequentially.

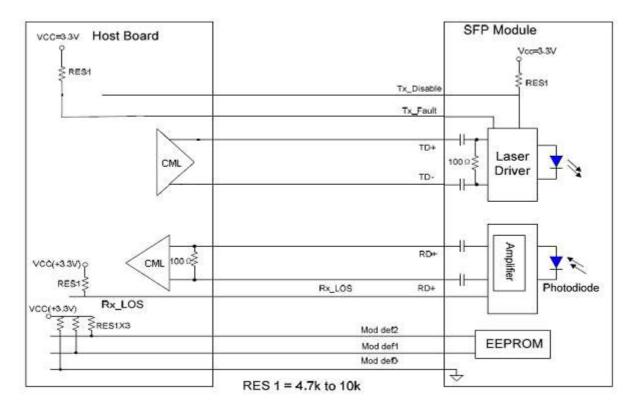
The Module provides diagnostic information about the present operating conditions. The transceiver generates this diagnostic data by digitization of internal analog signals. Calibration and alarm/warning threshold data is written during device manufacture. Received power monitoring, transmitted power monitoring, bias current monitoring, supply voltage monitoring and temperature monitoring all are implemented. The diagnostic data are raw A/D values and must be converted to real world units using calibration constants stored in EEPROM locations 56 – 95 at wire serial bus address A2h. The digital diagnostic memory map specific data field define as following .For detail EEPROM information, please refer to the related document of SFF 8472 Rev 9.3.



2 wire address 1010001X (A2h)







## **Recommend Circuit Schematic**

### **Mechanical Specifications**

